

ABSTRACT

Disclosed is an adhesive composition containing an epoxy resin, a phenolic resin, an elastomer, and a filler, in which a content of the filler is 40% to 68% by mass based on the total amount of the epoxy resin, the phenolic resin, the elastomer, and the filler, and the epoxy resin includes an epoxy resin having a naphthalene skeleton.

No Suitable Figure